

## ABSTRACT OF THE DISCLOSURE

It is an object of the present invention to provide a method for manufacturing a multi-layered unit for a multi-layered ceramic electronic component which can reliably prevent short circuit failure from occurring in a multi-layered ceramic electronic component.

According to the present invention, a multi-layered unit for a multi-layered ceramic electronic component is fabricated by printing a conductive paste containing an acrylic system resin as a binder and at least one solvent selected from a group consisting of limonene,  $\alpha$ -terpinyl acetate, l-dihydrocarvyl acetate, l-menthone, l-peryllil acetate, l-carvyl acetate, and d-dihydrocarvyl acetate as a solvent on a ceramic green sheet containing a butyral system resin as a binder in a predetermined pattern, thereby forming an electrode layer.